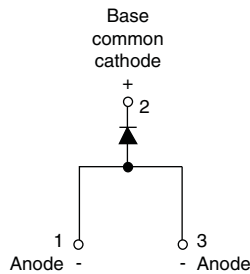




Surface Mountable Fast Soft Recovery Diode, 8 A



D-PAK



FEATURES

- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Compliant to RoHS Directive 2002/95/EC
- Halogen-free according to IEC 61249-2-21 definition



RoHS COMPLIANT HALOGEN FREE

APPLICATIONS

- Output rectification and freewheeling diode in inverters, choppers and converters
- Input rectifications where severe restrictions on conducted EMI should be met

DESCRIPTION

The VS-8EWF..S-M3 fast soft recovery rectifier series has been optimized for combined short reverse recovery time, low forward voltage drop and low leakage current.

The glass passivation ensures stable reliable operation in the most severe temperature and power cycling conditions.

| PRODUCT SUMMARY | |
|-----------------|---------------------|
| Package | D-PAK (TO-252AA) |
| $I_{F(AV)}$ | 8 A |
| V_R | 200 V, 400 V, 600 V |
| V_F at I_F | 1.2 V |
| I_{FSM} | 120 A |
| t_{rr} | 55 ns |
| Diode variation | Single die |
| Snap | 0.5 |

| MAJOR RATINGS AND CHARACTERISTICS | | | |
|-----------------------------------|---------------------------|-------------|-------|
| SYMBOL | CHARACTERISTICS | VALUES | UNITS |
| $I_{F(AV)}$ | Sinusoidal waveform | 8 | A |
| V_{RRM} | | 200 to 600 | V |
| I_{FSM} | | 120 | A |
| V_F | 8 A, $T_J = 25\text{ °C}$ | 1.2 | V |
| t_{rr} | 1 A, 100 A/ μ s | 55 | ns |
| T_J | Range | - 40 to 150 | °C |

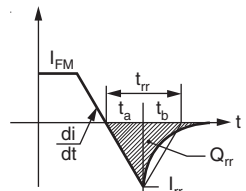
| VOLTAGE RATINGS | | | |
|-----------------|-----------------------------------------------|--------------------------------------------------------------|---------------------------|
| PART NUMBER | V_{RRM} , MAXIMUM PEAK REVERSE VOLTAGE V | V_{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V | I_{RRM} AT 150 °C mA |
| VS-8EWF02S-M3 | 200 | 300 | 3 |
| VS-8EWF04S-M3 | 400 | 500 | |
| VS-8EWF06S-M3 | 600 | 700 | |

| ABSOLUTE MAXIMUM RATINGS | | | | |
|-----------------------------------------------------|-----------------|------------------------------------------------------------|--------|---------------------------|
| PARAMETER | SYMBOL | TEST CONDITIONS | VALUES | UNITS |
| Maximum average forward current | $I_{F(AV)}$ | $T_C = 96\text{ °C}$, 180° conduction half sine wave | 8 | A |
| Maximum peak one cycle non-repetitive surge current | $I_{FSM}^{(1)}$ | 10 ms sine pulse, rated V_{RRM} applied | 101 | |
| | | 10 ms sine pulse, no voltage reapplied | 120 | |
| Maximum I^2t for fusing | I^2t | 10 ms sine pulse, rated V_{RRM} applied | 51 | A ² s |
| | | 10 ms sine pulse, no voltage reapplied | 72 | |
| Maximum $I^2\sqrt{t}$ for fusing | $I^2\sqrt{t}$ | $t = 0.1\text{ ms to }10\text{ ms}$, no voltage reapplied | 510 | A ² \sqrt{s} |

Note

(1) Connecting one pin only.

| ELECTRICAL SPECIFICATIONS | | | | | |
|---------------------------------|-------------|---------------------------------------|-------------------------------|--------|------------------|
| PARAMETER | SYMBOL | TEST CONDITIONS | | VALUES | UNITS |
| Maximum forward voltage drop | V_{FM} | 8 A, $T_J = 25\text{ }^\circ\text{C}$ | | 1.2 | V |
| Forward slope resistance | r_t | $T_J = 150\text{ }^\circ\text{C}$ | | 16 | $\text{m}\Omega$ |
| Threshold voltage | $V_{F(TO)}$ | | | 1.13 | V |
| Maximum reverse leakage current | I_{RM} | $T_J = 25\text{ }^\circ\text{C}$ | $V_R = \text{Rated } V_{RRM}$ | 0.1 | mA |
| | | $T_J = 150\text{ }^\circ\text{C}$ | | 3 | |

| RECOVERY CHARACTERISTICS | | | | | |
|--------------------------|----------|----------------------------------------------------------------------------|--------|---------------|-------------------------------------------------------------------------------------|
| PARAMETER | SYMBOL | TEST CONDITIONS | VALUES | UNITS |  |
| Reverse recovery time | t_{rr} | I_F at 1 Apk 100 A/ μs $T_J = 25\text{ }^\circ\text{C}$ | 55 | ns | |
| | | I_F at 8 Apk 25 A/ μs $T_J = 25\text{ }^\circ\text{C}$ | 140 | | |
| Reverse recovery current | I_{rr} | 25 A/ μs $T_J = 25\text{ }^\circ\text{C}$ | 2.6 | A | |
| Reverse recovery charge | Q_{rr} | | 0.25 | μC | |
| Snap factor | S | | 0.5 | | |

| THERMAL - MECHANICAL SPECIFICATIONS | | | | |
|-------------------------------------------------------------|------------------|-----------------------------|-------------|---------------------------|
| PARAMETER | SYMBOL | TEST CONDITIONS | VALUES | UNITS |
| Maximum junction and storage temperature range | T_J, T_{Stg} | | - 40 to 150 | $^\circ\text{C}$ |
| Soldering temperature | T_S | For 10 seconds | 240 | |
| Maximum thermal resistance, junction to case | R_{thJC} | DC operation | 2.5 | $^\circ\text{C}/\text{W}$ |
| Typical thermal resistance, junction to ambient (PCB mount) | $R_{thJA}^{(1)}$ | | 50 | |
| Approximate weight | | | 1 | g |
| | | | 0.03 | oz. |
| Marking device | | Case style TO-252AA (D-PAK) | 8EWF02S | |
| | | | 8EWF04S | |
| | | | 8EWF06S | |

Note

⁽¹⁾ When mounted on 1" square (650 mm²) PCB of FR-4 or G-10 material 4 oz. (140 μm) copper 40 $^\circ\text{C}/\text{W}$
For recommended footprint and soldering techniques refer to application note #AN-994



VS-8EWF02S-M3, VS-8EWF04S-M3, VS-8EWF06S-M3

Surface Mountable Fast Soft
Recovery Diode, 8 A

Vishay Semiconductors

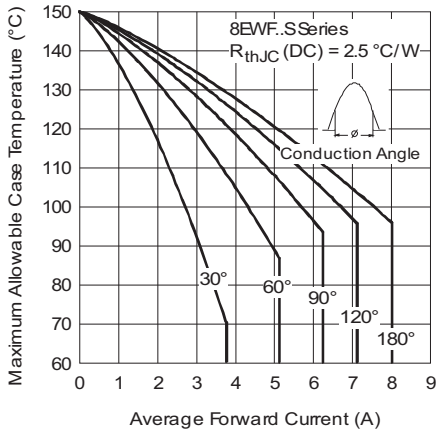


Fig. 1 - Current Rating Characteristics

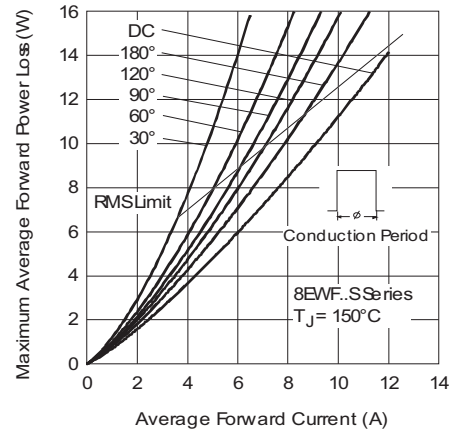


Fig. 4 - Forward Power Loss Characteristics

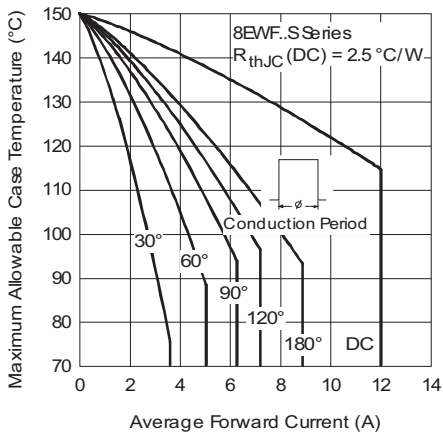


Fig. 2 - Current Rating Characteristics

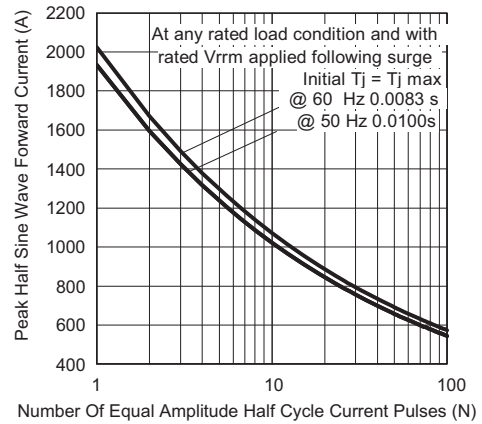


Fig. 5 - Maximum Non-Repetitive Surge Current

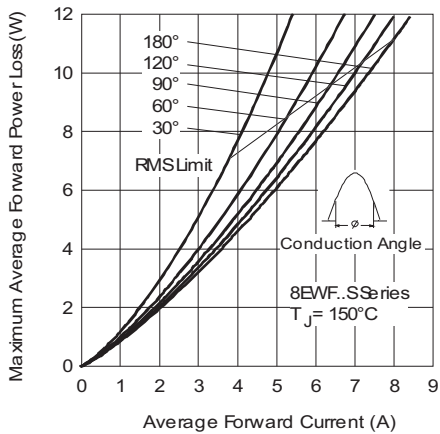


Fig. 3 - Forward Power Loss Characteristics

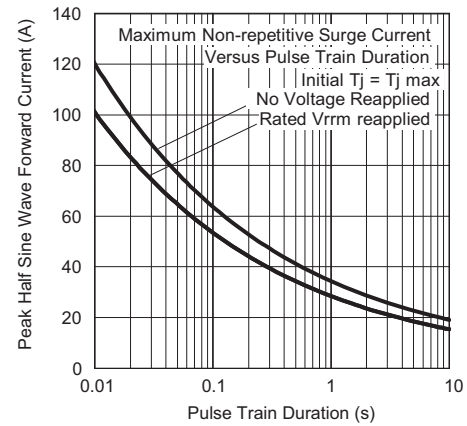


Fig. 6 - Maximum Non-Repetitive Surge Current

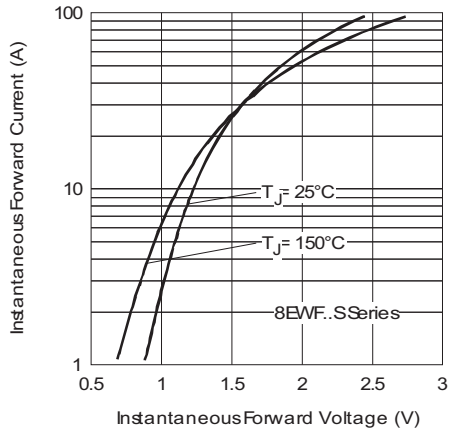


Fig. 7 - Forward Voltage Drop Characteristics

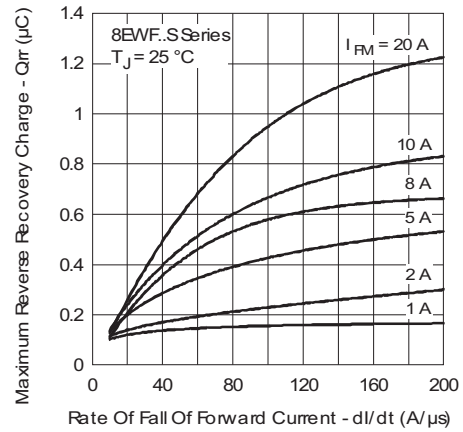


Fig. 10 - Recovery Charge Characteristics, $T_J = 25\text{ }^\circ\text{C}$

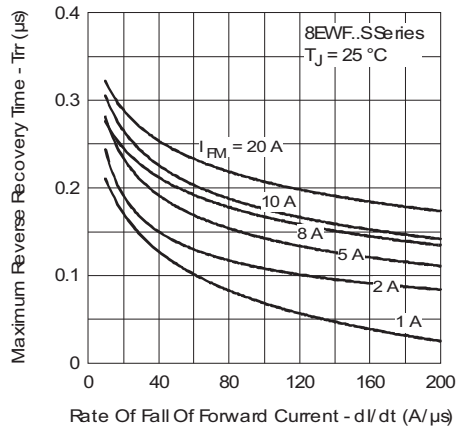


Fig. 8 - Recovery Time Characteristics, $T_J = 25\text{ }^\circ\text{C}$

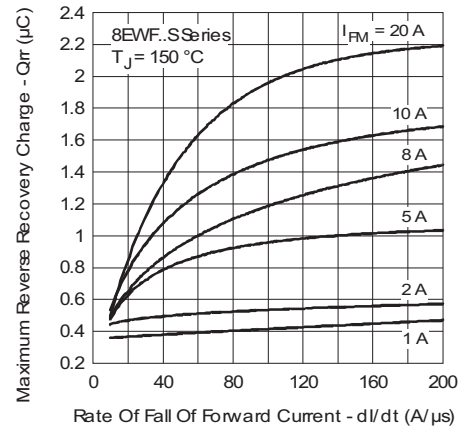


Fig. 11 - Recovery Charge Characteristics, $T_J = 150\text{ }^\circ\text{C}$

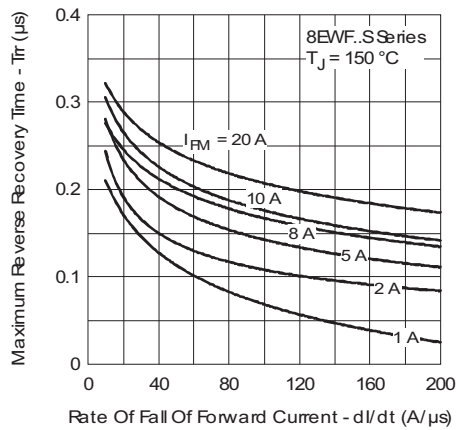


Fig. 9 - Recovery Time Characteristics, $T_J = 150\text{ }^\circ\text{C}$

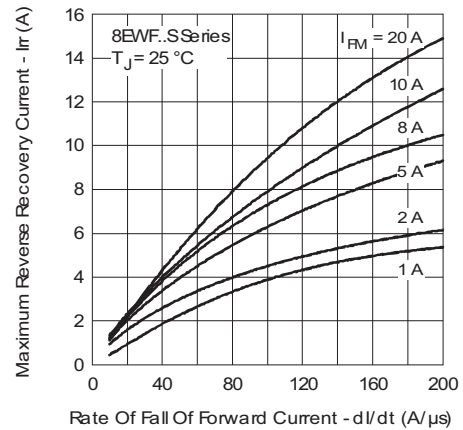


Fig. 12 - Recovery Current Characteristics, $T_J = 25\text{ }^\circ\text{C}$



VS-8EWF02S-M3, VS-8EWF04S-M3, VS-8EWF06S-M3

Surface Mountable Fast Soft
Recovery Diode, 8 A

Vishay Semiconductors

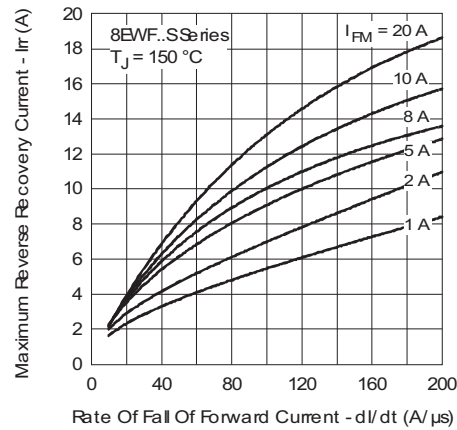


Fig. 13 - Recovery Current Characteristics, $T_J = 150\text{ }^\circ\text{C}$

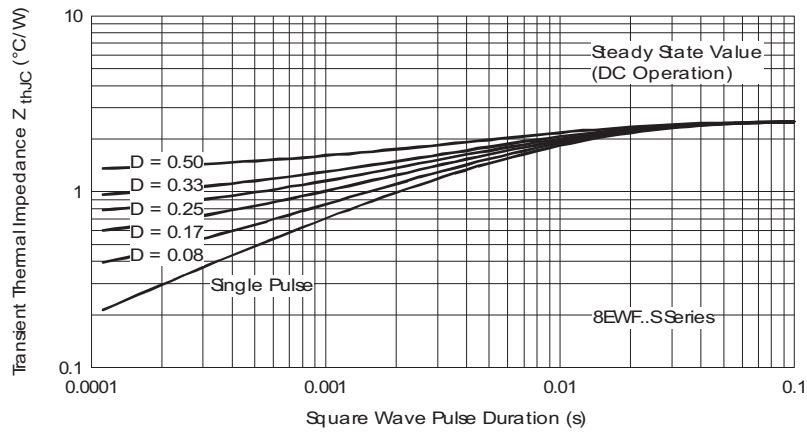


Fig. 14 - Thermal Impedance Z_{thJC} Characteristics

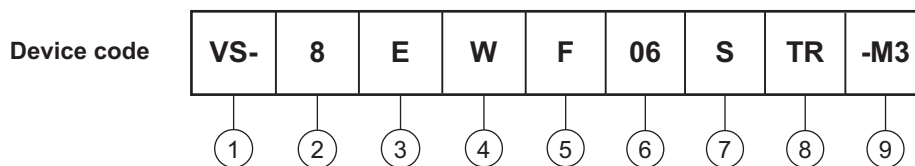
VS-8EWF02S-M3, VS-8EWF04S-M3, VS-8EWF06S-M3



Vishay Semiconductors

Surface Mountable Fast Soft
Recovery Diode, 8 A

ORDERING INFORMATION TABLE



- 1** - Vishay Semiconductors product
- 2** - Current rating (8 = 8 A)
- 3** - Circuit configuration:
E = Single diode
- 4** - Package:
W = D-PAK
- 5** - Type of silicon:
F = Fast soft recovery rectifier
- 6** - Voltage code x 100 = V_{RRM}

| |
|------------|
| 02 = 200 V |
| 04 = 400 V |
| 06 = 600 V |
- 7** - S = Surface mountable
- 8** -
 - TR = Tape and reel
 - TRR = Tape and reel (right oriented)
 - TRL = Tape and reel (left oriented)
- 9** - Environmental digit:
-M3 = Halogen-free, RoHS compliant and terminations lead (Pb)-free

| ORDERING INFORMATION (Example) | | | |
|--------------------------------|------------------|------------------------|--------------------------|
| PREFERRED P/N | QUANTITY PER T/R | MINIMUM ORDER QUANTITY | PACKAGING DESCRIPTION |
| VS-8EWF02S-M3 | 75 | 3000 | Antistatic plastic tubes |
| VS-8EWF02STR-M3 | 2000 | 2000 | 13" diameter reel |
| VS-8EWF02STRL-M3 | 3000 | 3000 | 13" diameter reel |
| VS-8EWF02STRR-M3 | 3000 | 3000 | 13" diameter reel |
| VS-8EWF04S-M3 | 75 | 3000 | Antistatic plastic tubes |
| VS-8EWF04STR-M3 | 2000 | 2000 | 13" diameter reel |
| VS-8EWF04STRL-M3 | 3000 | 3000 | 13" diameter reel |
| VS-8EWF04STRR-M3 | 3000 | 3000 | 13" diameter reel |
| VS-8EWF06S-M3 | 75 | 3000 | Antistatic plastic tubes |
| VS-8EWF06STR-M3 | 2000 | 2000 | 13" diameter reel |
| VS-8EWF06STRL-M3 | 3000 | 3000 | 13" diameter reel |
| VS-8EWF06STRR-M3 | 3000 | 3000 | 13" diameter reel |

| LINKS TO RELATED DOCUMENTS | |
|----------------------------|------------------------------------------------------------------------|
| Dimensions | www.vishay.com/doc?95016 |
| Part marking information | www.vishay.com/doc?95176 |
| Packaging information | www.vishay.com/doc?95033 |

D-PAK (TO-252AA)



| SYMBOL | MILLIMETERS | | INCHES | | NOTES |
|--------|-------------|------|--------|-------|-------|
| | MIN. | MAX. | MIN. | MAX. | |
| A | 2.18 | 2.39 | 0.086 | 0.094 | |
| A1 | - | 0.13 | - | 0.005 | |
| b | 0.64 | 0.89 | 0.025 | 0.035 | |
| b2 | 0.76 | 1.14 | 0.030 | 0.045 | |
| b3 | 4.95 | 5.46 | 0.195 | 0.215 | 3 |
| c | 0.46 | 0.61 | 0.018 | 0.024 | |
| c2 | 0.46 | 0.89 | 0.018 | 0.035 | |
| D | 5.97 | 6.22 | 0.235 | 0.245 | 5 |
| D1 | 5.21 | - | 0.205 | - | 3 |
| E | 6.35 | 6.73 | 0.250 | 0.265 | 5 |
| E1 | 4.32 | - | 0.170 | - | 3 |

| SYMBOL | MILLIMETERS | | INCHES | | NOTES |
|--------|-------------|-------|------------|-------|-------|
| | MIN. | MAX. | MIN. | MAX. | |
| e | 2.29 BSC | | 0.090 BSC | | |
| H | 9.40 | 10.41 | 0.370 | 0.410 | |
| L | 1.40 | 1.78 | 0.055 | 0.070 | |
| L1 | 2.74 BSC | | 0.108 REF. | | |
| L2 | 0.51 BSC | | 0.020 BSC | | |
| L3 | 0.89 | 1.27 | 0.035 | 0.050 | 3 |
| L4 | - | 1.02 | - | 0.040 | |
| L5 | 1.14 | 1.52 | 0.045 | 0.060 | 2 |
| Ø | 0° | 10° | 0° | 10° | |
| Ø1 | 0° | 15° | 0° | 15° | |
| Ø2 | 25° | 35° | 25° | 35° | |

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension uncontrolled in L5
- (3) Dimension D1, E1, L3 and b3 establish a minimum mounting surface for thermal pad
- (4) Section C - C dimension apply to the flat section of the lead between 0.13 and 0.25 mm (0.005 and 0.10") from the lead tip
- (5) Dimension D, and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (6) Dimension b1 and c1 applied to base metal only
- (7) Datum A and B to be determined at datum plane H
- (8) Outline conforms to JEDEC outline TO-252AA



Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk and agree to fully indemnify and hold Vishay and its distributors harmless from and against any and all claims, liabilities, expenses and damages arising or resulting in connection with such use or sale, including attorneys fees, even if such claim alleges that Vishay or its distributor was negligent regarding the design or manufacture of the part. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- Конкурентоспособные цены и скидки постоянным клиентам.
- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



Тел: +7 (812) 336 43 04 (многоканальный)

Email: org@lifeelectronics.ru